

10% glass bead, low warpage, has been replaced by Hostaform® C 9021 GV3/10 Celcon® GB10 is a 10% glass bead filled grade for low shrinkage and warp resistance in large, flat, and thin walled parts. Chemical abbreviation according to ISO 1043-1: POM

Rheological properties

Melt mass-flow rate22Temperature190Load2.16Melt mass-flow rate, Temperature190	cm ³ /10min ISO 1133 g/10min ISO 1133 °C kg °C kg
Moulding shrinkage range, parallel 1.9	% ISO 294-4, 2577
Moulding shrinkage range, normal 1.6	i % ISO 294-4, 2577
Typical mechanical properties	
Yield stress, 50mm/min55Yield strain, 50mm/min7Strain at break, 50mm/min10	MPa ISO 527-1/-2 MPa ISO 527-1/-2 % ISO 179/1eA
Thermal properties	
3 - - - - - - - - - -	°C ISO 11357-1/-3 °C ISO 75-1/-2
Other properties	
Density 1470	kg/m ³ ISO 1183
Injection	
Drying Temperature100 - 120Drying Time, Dehumidified Dryer3 - 2Max. mould temperature90 - 120Back pressure2Injection speedslow	h °C ? MPa

Additional information

Injection molding

Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.

Printed: 2023-09-15



Page: 1 of 5





Melt Temperature: Preferred range 182-199 C (360-390 F). Melt temperature should never exceed 230 C (450 F).

Mold Surface Temperature: Preferred range 82-93 C (180-200 F) especially with wall thickness less than 1.5 mm (0.060 in.). May require mold temperature as high as 120 C (250 F) to reproduce mold surface or to assure minimal molded in stress. Wall thickness greater than 3mm (1/8 in.) may use a cooler (65 C/150 F) mold surface temperature and wall thickness over 6mm (1/4 in.) may use a cold mold surface down to 25 C (80 F). In general, mold surface temperatures lower than 82 C (180 F) may hinder weld line formation and produce a hazy surface or a surface with flow lines, pits and other included defects that can hinder part performance.

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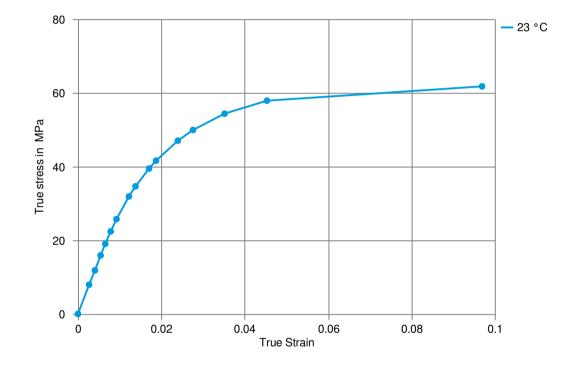


Page: 2 of 5





True stress-strain



Printed: 2023-09-15



Page: 3 of 5





Processing Texts	
Pre-drying	Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.
Injection molding	Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.
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Injection molding Preprocessing	Drying is generally not required because Celcon® and Hostaform® acetal copolymers are not hydroscopic nor are they degraded by moisture during processing. Excessive moisture can lead to splay (silver streaking) in molded parts. For better uniformity in molding especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying conditions are 80 C (180 F) for 3hours. Desiccant hopper dryers are not required. Maximum water content = 0.35%
Injection molding Postprocessing	Postprocessing conditioning and moisturizing are not required. It may be necessary to fixture large or complicated parts with varying wall thickness to prevent warpage while cooling to ambient temperature.

Printed: 2023-09-15



Page: 4 of 5

